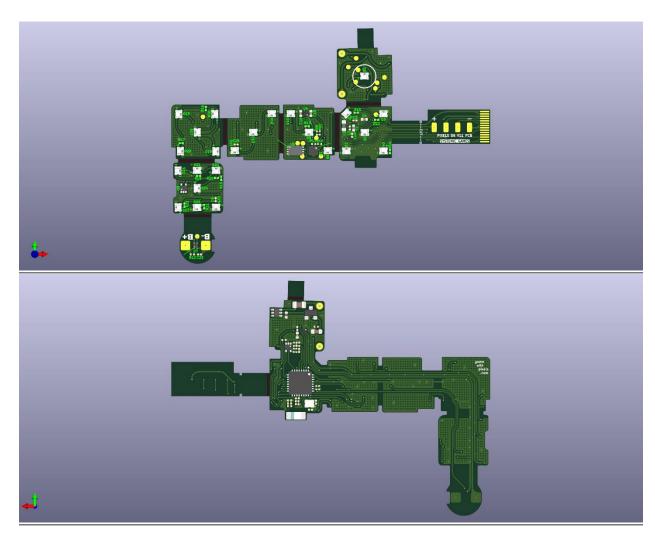
## D6V11 FPC Specifications



<u>PCB Type :</u> Flexible PCB <u>Board type :</u> Single pieces

Layer: 2 Layers

Material : Polyimide Flex: FPC Thickness : 0.13 mm

Solder Mask (Coverlay): Black Coverlay

Silkscreen: White / Black

Stiffener: BOT FR4: 0.15 mm

filename: Main-B\_Stiffener.gbr

Surface Finish: Immersion gold (ENIG) (1U") Finished Copper: 0.5 oz Annealed Cu (18µm)

E-test : 100%

3M/Tesa tape : BOT

Glue: Main-B\_3M\_Adhesive.gbr

Backing Tape: *Main-B\_3M\_Backing.gbr* 

SMT: TOP + BOT